HFD3-V

SUBMINIATURE SIGNAL RELAY



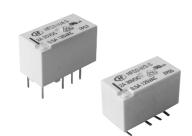
File No.: E133481



File No.: 40018867



File No.:CQC14002107409



Features

- 3kV dielectric strength (between coil and contacts)
- Surge withstand voltage up to 6000VAC, meets FCC Part 68 and Telecordia
- Min. creepage is 2.5mm (between coil and contact),
 Min. clearance is 2.0mm (between coil and contact)
- 2 pairs of NO contacts connected in series with contact gap ≥1.5mm
- Meets EN60950 / EN41003
- SMT and DIP types available
- Bifurcated contacts
- Single side stable and latching types available
- Environmental friendly product (RoHS compliant)
- Outline Dimensions: (15.0 x 7.5 x 9.2) mm

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Contact arrangement	20
Contact resistance	100mΩ max. (at 10mA 30mVDC)
Contact material	AgPd + Au plated, AgNi + Au plated
Contact rating (Res. load)	2A 30VDC 0.5A 125VAC 1A 277VAC
Max. switching current	4A
Max. switching voltage	700VAC / 1000VDC (2 pairs of NO contacts connected in series) 400VAC / 600VDC (1 pair of contacts)
Max. switching power	62.5VA / 60W
Min. applicable load	10mV 10µA ¹⁾
Mechanical endurance	1 x 10 ⁷ ops
Electrical endurance ²⁾	1 x 10 ⁵ ops (0.5A 125VAC, Resistive load, AgNi + Au plated at 85°C, 1s on 9s off)

Notes: 1) Min. applicable load is reference value. Please perform the confirmation test with the actual load before production since reference value may change according to switching frequencies, environmental conditions and expected contact resistance and reliability.

2) Electric endurance data are collected in one pair CO contact test.

SAFETY APPROVAL RATINGS

UL/CUL	AgNi + Au plated	2A 30VDC at 85°C 0.5A 125VAC at 85°C 1A 277VAC at 85°C
	AgPd + Au plated	0.5A 125VAC at 70°C
\/DE	A - N	2A 30VDC at 85°C
VDE	AgNi + Au plated	0.5A 125VAC at 85°C

Notes: 1) All values unspecified are at room temperature.

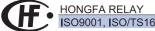
 Only typical loads are listed above. Other load specifications can be available upon request.

CHARACTERISTICS

Insulation	resistance	1000MΩ (at 500VDC			
D: 1 (:	Between coil & contacts	3000VAC/4200VDC 1min			
Dielectric strength	Between open contacts	1500VAC/2100VDC 1min			
	Between contact sets	1500VAC/2100VDC 1min			
Between o	nstand voltage open contacts(10/160µs) coil & contacts(1.2/50µs)	2.5kV 6kV			
Operate ti	me (Set time)	6ms max.			
Release t	ime (Reset time)	6ms max.			
Ambient to	emperature	-40°C to 85°C			
Humidity		5% to 85% RH			
Vibration	Functional	10Hz to 55Hz 3.3mm DA			
resistance	Destructive	10Hz to 55Hz 5.0mm DA			
Shock	Functional	735m/s ²			
resistance	Destructive	980m/s			
Termination	on	DIP, SMT			
Unit weigl	nt	Approx. 2g			
	sensitivity levels (Only for , JEDEC-STD-020)	MSL-3			
Construct	ion	Plastic sealed			
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Notes: The data shown above are initial values.

COIL		
Coil power	Single side stable	200mW
Coil power	1 coil latching	140mW
Temperature rise		70K max.



COIL DATA at 23°C

Single side stable

Coil Code	Nominal Voltage VDC	Pick-up Voltage VDC max.	Drop-out Voltage VDC min.	Coil Resistance Ω	Nominal Power mW	Max. Voltage VDC
HFD3-V/1.5	1.5	1.13	0.15	11.2 x (1±10%)	200	2.2
HFD3-V/2.4	2.4	1.8	0.24	28.8 x (1±10%)	200	3.6
HFD3-V/3	3	2.25	0.3	45 x (1±10%)	200	4.5
HFD3-V/4.5	4.5	3.38	0.45	101 x (1±10%)	200	6.7
HFD3-V/5	5	3.75	0.5	125 x (1±10%)	200	7.5
HFD3-V/6	6	4.5	0.6	180 x (1±10%)	200	9
HFD3-V/9	9	6.75	0.9	405 x (1±10%)	200	13.5
HFD3-V/12	12	9	1.2	720 x (1±10%)	200	18
HFD3-V/24	24	18	2.4	2880 x (1±10%)	200	36

1 coil latching

Coil Code	Nominal Voltage VDC	Pick-up Voltage VDC max.	Drop-out Voltage VDC max.	Coil Resistance Ω	Nominal Power mW	Max. Voltage VDC
HFD3-V/1.5-L1	1.5	1.13	1.13	16.1 x (1±10%)	140	2.7
HFD3-V/2.4-L1	2.4	1.8	1.8	41 x (1±10%)	140	4.3
HFD3-V/3-L1	3	2.25	2.25	64.3 x (1±10%)	140	5.4
HFD3-V/4.5-L1	4.5	3.38	3.38	145 x (1±10%)	140	8.1
HFD3-V/5-L1	5	3.75	3.75	178 x (1±10%)	140	9
HFD3-V/6-L1	6	4.5	4.5	257 x (1±10%)	140	10.8
HFD3-V/9-L1	9	6.75	6.75	579 x (1±10%)	140	16.2
HFD3-V/12-L1	12	9	9	1028 x (1±10%)	140	21.6
HFD3-V/24-L1	24	18	18	4114 x (1±10%)	140	43.2

Notes: 1) In case 5V of transistor drive circuit, it is recommended to use 4.5V type relay, and 3V to use 2.4V type relay.

ORDERING INFORMATION HFD3-V / 24 S -L1 **Type** Coil voltage 1.5, 2.4, 3, 4.5, 5, 6, 9, 12, 24VDC Sort L1: 1 coil latching Nil: Single side stable Contact material 4: AgPd+Gold plated Nil: AgNi+Gold plated **Terminal type** S: Standard SMT S1: Short terminal SMT Nil: DIP R: Tape and reel packing (Only for SMT type)₁ Packing style Nil: Tube packing(Only for DIP type)³⁾ Special code⁴⁾ **XXX:** Customer special requirement Nil: Standard

Notes: 1) R type (tape and reel) packing is moisture-proof which meets requirement of MSL-3. Please choose R type packing for SMT products. For R type, the letter "R" will only be printed on packing tag but not on relay cover. Tube packing is normally not available for SMT products unless specially requested by customer. But please note that tube packing is not moisture-proof so please bake the products before use according to description of Notice 11 herewith. In addition, tube packaging will be adopted when the ordering quantity of R type is equal to or less than 100 pieces unless otherwise specified.

²⁾ When coil sort, contact material, terminal type or packing style are needed, pleaes add "-" after coil voltage is selected. For instance, HFD3-V/12-4SR.

³⁾The standard tube length is 624mm.

⁴⁾ The customer special requirement express as special code after evaluating by Hongfa. e.g. (131): The Dielectric strength between coil & contacts is 3000VAC 1min for single side stable and 1 coil latching version.

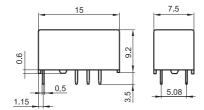
OUTLINE DIMENSIONS, WIRING DIAGRAM AND PC BOARD LAYOUT

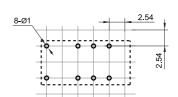
Unit: mm

Outline Dimensions

PCB Layout (Bottom view)

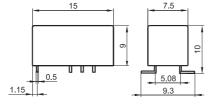
DIP type

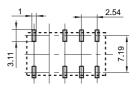




S type:

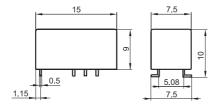
Standard SMT

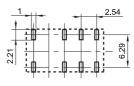




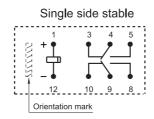
S1 type:

Short terminal SMT

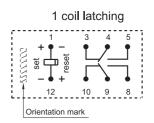




Wiring Diagram (Bottom view)



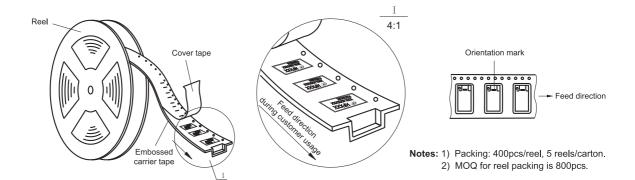
No energized condition

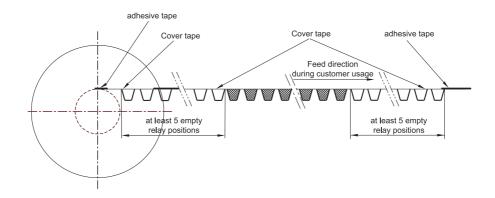


reset condition

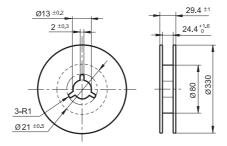
TAPE PACKING Unit: mm

Direction of Relay Insertion





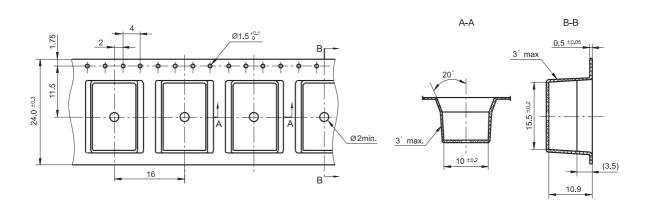
Reel Dimensions

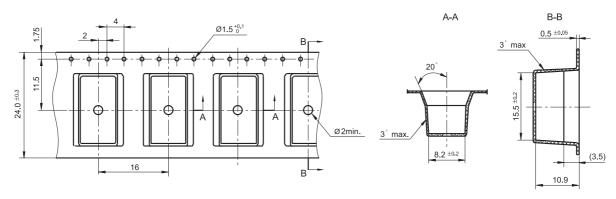


Tape Dimensions (S type: Standard SMT)

TAPE PACKING Unit: mm

Tape Dimensions (S1 type: Short terminal SMT)





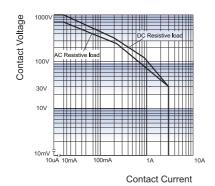
Remark: 1) In case of no tolerance shown in outline dimension: outline dimension \leq 1mm, tolerance should be \pm 0.2mm; outline dimension >1mm and \leq 5mm, tolerance should be \pm 0.3mm; outline dimension >5mm, tolerance should be \pm 0.4mm.

- 2) The tolerance without indicating for PCB layout is always ±0.1mm.
- 3) The width of the gridding is 2.54mm.

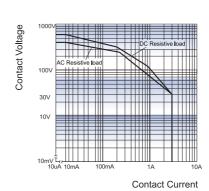
CHARACTERISTIC CURVES

MAXIMUM SWITCHING POWER





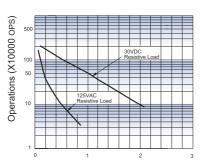
1 pair of contacts



61

CHARACTERISTIC CURVES

ENDURANCE CURVE

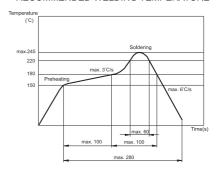


Contact Current (A)

Test conditions:

Resistive load, at 85°C, 1s on 9s off.

REFLOW WELDING, TEMPERATURE ON PCB BOARD RECOMMENDED WELDING TEMPERATURE



Notice

- 1) This relay is highly sensitive polarized relay, if correct polarity is not applied to the coil terminals, the relay does not operate properly.
- 2) To avoid using relays under strong magnetic field which will change the parameters of relays such as pick-up voltage and drop-out voltage.
- 3) Relay is on the "reset" status when being released from stock, with the consideration of shock risen from transit and relay mounting, it should be changed to the "set" status when application(connecting to the power supply). Please reset the relay to "set" or "reset" status on request.
- 4) Energizing coil with rated voltage is basic for normal operation of a relay, please make sure the energized voltage to relay coil have reached the rated voltage. Regarding latching relay, in order to maintain the "set" or "reset" status, impulse width of the rated voltage applied to coil should be more than 5 times of "set" or "reset" time.
- 5) The relay may be damaged because of falling or when shocking conditions exceed the requirement.
- 6) For SMT products, validation with real application should be done before your series production, if the reflow-soldering temperature curve is out of our recommendation. Generally, two-time reflow-soldering is not recommended for the relay. However, if two-time reflow-soldering is required, a 60-min. interval should be guaranteed and a validation should be done before production.
- 7) Contact is recommended for suitable condition and specifications if water cleaning or surface process is involved in assembling relays on PCB.
- 8) Regarding the plastic sealed relay, we should leave it cooling naturally untill below 40°C after welding, then clean it and deal with coating, remarkably the temperature of solvents should also be controlled below 40°C. Please avoid cleaning the relay by ultrasonic, avoid using the solvents like gasoline, Freon, and so on, which would affect the configuration of relay or influence the environment.
- 9) About preferable condition of operation, storage and transportation, please refer to "Explanation to terminology and guidetines of relay".
- 10) Relays packaged in moisture barrier bags meet MSL-3 requirements. The relays should be stored at ambient conditions of ≤30 ℃ and ≤60% RH after they are removed from their packaging, and should be used within 168 hours. If the relays cannot be used within 168 hours, please repack them or store them in a drying oven at 25 ℃ ±5 ℃, ≤10% RH. Otherwise, relays may be subjected to a soldering test to check their performance, or they may be used after keeping them in an oven for 72 hours at with 50 ℃ ±5 ℃, ≤30% RH.

Disclaimer

The specification is for reference only. See to "Terminology and Guidelines" for more information. Specifications subject to change without notice. We could not evaluate all the performance and all the parameters for every possible application. Thus the user should be in a right position to choose the suitable product for their own application. If there is any query, please contact Hongfa for the technical service. However, it is the user's responsibility to determine which product should be used only.

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